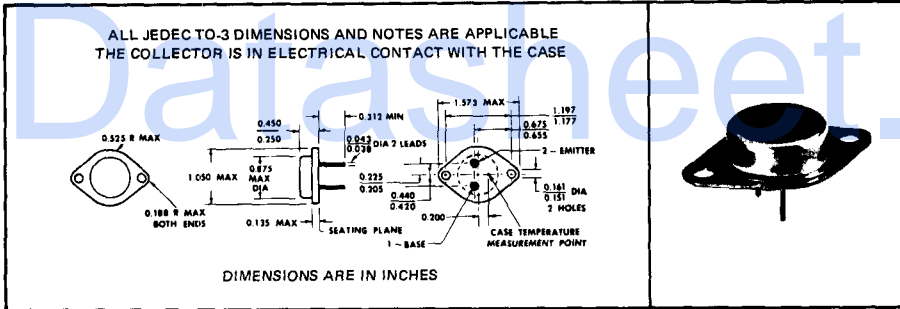


TYPE 2N5157 N-P-N SILICON POWER TRANSISTOR

**HIGH VOLTAGE, HIGH FORWARD AND REVERSE ENERGY
DESIGNED FOR INDUSTRIAL AND MILITARY APPLICATIONS**

- 100 W at 75°C Case Temperature
- 700 V Collector-Emitter Off-State Voltage
- Min $V_{(BR)CEO}$ of 400 V
- Max t_{off} of 1.7 μ s at $I_C = 1$ A
- Typ $V_{CE(sat)}$ of 0.3 V at $I_C = 3.5$ A
- Typ f_T of 5 MHz at 12 V, 0.2 A

***mechanical data**



absolute maximum ratings at 25°C case temperature (unless otherwise noted)

* Collector-Emitter Voltage ($V_{BE} = -1.5$ V, See Note 1)	700 V
* Collector-Emitter Voltage (Base Open, See Note 1)	500 V
* Emitter-Base Voltage	6 V
* Continuous Collector Current	3.5 A
* Continuous Base Current	2 A
Safe Operating Area at (or below) 75°C Case Temperature	See Figure 6
* Continuous Device Dissipation at (or below) 75°C Case Temperature (See Note 2)	100 W
Continuous Device Dissipation at (or below) 25°C Free-Air Temperature (See Note 3)	4 W
Unclamped Inductive Load Energy (See Note 4)	180 mJ
* Operating Collector Junction Temperature Range	-65°C to 150°C
* Storage Temperature Range	-65°C to 200°C
* Terminal Temperature 1/16 Inch from Case for 10 Seconds	300°C

NOTES: 1. These values apply only when the collector-emitter voltage is applied with the transistor in the off-state with the base-emitter diode reverse-biased or open-circuited, as specified. In operation, the limitations of Figure 6 must be observed.
 2. Derate linearly to 150°C case temperature at the rate of 1.33 W/°C.
 3. Derate linearly to 150°C free-air temperature at the rate of 32 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in the circuit of Figure 2, condition 1. L = 40 mH, $R_{BB2} = 3$ k Ω , $V_{BB2} = 1.5$ V, $R_S = 0.1$ Ω , $V_{CC} = 50$ V. Energy $\approx I_C^2 L/2$.

* JEDEC registered data. This data sheet contains all applicable registered data in effect at the time of publication.

TYPE 2N5157

N-P-N SILICON POWER TRANSISTOR

*electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	$I_C = 100 \text{ mA}$, $I_B = 0$, See Note 5	400			V
$V_{(BR)CEB}$	Collector-Emitter Breakdown Voltage	$I_{CM} = 3.5 \text{ A}$, $R_{BE} = 10 \Omega$, See Figure 2 (Condition 2)	500			V
I_{CEO}	Collector Cutoff Current	$V_{CE} = 500 \text{ V}$, $I_B = 0$			0.25	mA
I_{CEV}	Collector Cutoff Current	$V_{CE} = 700 \text{ V}$, $V_{BE} = -1.5 \text{ V}$			0.5	mA
		$V_{CE} = 400 \text{ V}$, $V_{BE} = -1.5 \text{ V}$, $T_C = 125^\circ\text{C}$			0.5	
I_{EBO}	Emitter Cutoff Current	$V_{EB} = 6 \text{ V}$, $I_C = 0$			5	mA
h_{FE}	Static Forward Current Transfer Ratio	$V_{CE} = 5 \text{ V}$, $I_C = 1 \text{ A}$		30	90	
		$V_{CE} = 5 \text{ V}$, $I_C = 2.5 \text{ A}$	See Notes 5 and 6	10		
		$V_{CE} = 5 \text{ V}$, $I_C = 1 \text{ A}$, $T_C = -55^\circ\text{C}$		10		
V_{BE}	Base-Emitter Voltage	$I_B = 0.7 \text{ A}$, $I_C = 3.5 \text{ A}$, See Notes 5 and 6		1.1	2	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_B = 0.1 \text{ A}$, $I_C = 1 \text{ A}$		0.2	0.8	V
		$I_B = 0.7 \text{ A}$, $I_C = 3.5 \text{ A}$	See Notes 5 and 6	0.3	2.5	
$ h_{fe} $	Small-Signal Common-Emitter Forward Current Transfer Ratio	$V_{CE} = 12 \text{ V}$, $I_C = 0.2 \text{ A}$, $f = 1 \text{ MHz}$	2.8	5		
C_{obo}	Common-Base Open-Circuit Output Capacitance	$V_{CB} = 20 \text{ V}$, $I_E = 0$, $f = 1 \text{ MHz}$	100	150		pF

NOTES: 5. These parameters must be measured using pulse techniques. $t_w = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 0.125 inch from the device body.

thermal characteristics

PARAMETER		MAX	UNIT
$R_{\theta JC}$	Junction-to-Case Thermal Resistance	0.75	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction-to-Free-Air Thermal Resistance	31.25	

*switching characteristics at 25°C case temperature

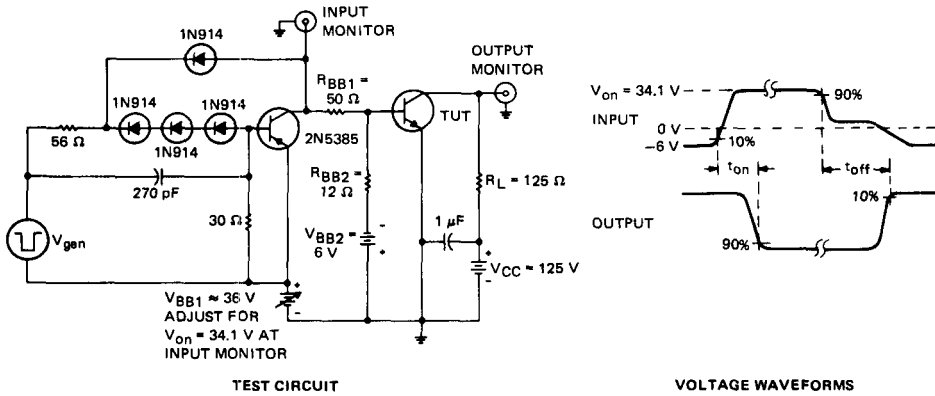
PARAMETER		TEST CONDITIONS†	MAX	UNIT
t_{on}	Turn-On Time	$I_C = 1 \text{ A}$, $I_B(1) = 0.1 \text{ A}$, $I_B(2) = -0.5 \text{ A}$,	0.8	μs
t_{off}	Turn-Off Time	$V_{BE(off)} = -6 \text{ V}$, $R_L = 125 \Omega$, See Figure 1	1.7	

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

*JEDEC registered data

TYPE 2N5157 N-P-N SILICON POWER TRANSISTOR

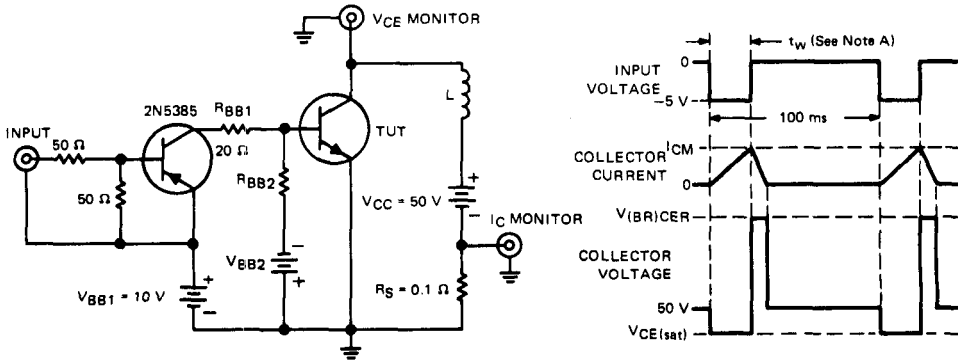
PARAMETER MEASUREMENT INFORMATION



- NOTES:**
- A. V_{gen} is a -30-V pulse (from 0 V) into a $50\text{-}\Omega$ termination.
 - B. The V_{gen} waveform is supplied by a generator with the following characteristics: $t_r \leq 15\text{ ns}$, $t_f \leq 15\text{ ns}$, $Z_{out} = 50\text{ }\Omega$, $t_w = 5\text{ }\mu\text{s}$, duty cycle $\leq 5\%$.
 - C. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r \leq 10\text{ ns}$, $R_{in} \geq 1\text{ M}\Omega$, $C_{in} \leq 11.5\text{ pF}$.
 - D. Resistors must be noninductive types.
 - E. The d-c power supplies may require additional bypassing in order to minimize ringing.

FIGURE 1

INDUCTIVE LOAD SWITCHING



CONDITION	R_{BB2}	V_{BB2}	L	I_{CM}	t_w
1	$3\text{ k}\Omega$	1.5 V	40 mH	3 A	$\approx 2.4\text{ ms}$
2	$10\text{ }\Omega$	0 V	10 mH	3.5 A	$\approx 0.7\text{ ms}$

NOTE A: Input pulse width is increased until the peak collector current reaches the specified value of I_{CM} .

FIGURE 2

TYPE 2N5157

N-P-N SILICON POWER TRANSISTOR

TYPICAL CHARACTERISTICS

STATIC FORWARD CURRENT TRANSFER RATIO VS COLLECTOR CURRENT

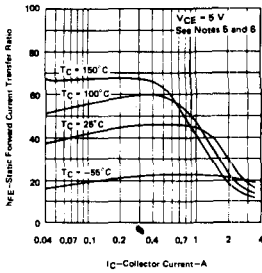


FIGURE 3

BASE-EMITTER VOLTAGE VS CASE TEMPERATURE

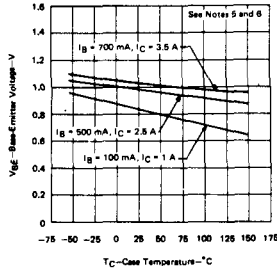


FIGURE 4

COLLECTOR-EMITTER SATURATION VOLTAGE VS CASE TEMPERATURE

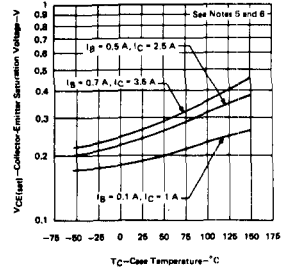


FIGURE 5

NOTES: 5. These parameters must be measured using pulse techniques. $t_W = 300 \mu s$, duty cycle $\leq 2\%$.

6. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 0.125 inch from the device body.

MAXIMUM SAFE OPERATING AREA

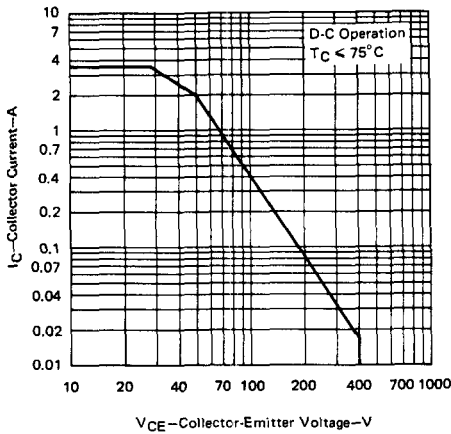


FIGURE 6

THERMAL INFORMATION

DISSIPATION DERATING CURVE

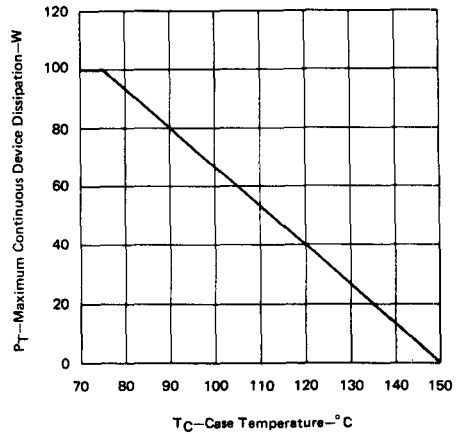


FIGURE 7

Typ type	P_{tot} $T_G = 25\text{ }^\circ\text{C}$ ($T_C = 100\text{ }^\circ\text{C}$) W	V_{CE0} min V	I_{CD} max A	min	h_{FE} max	@	I_C A
BUY 70 A	75	1000*	10	15			1,0
BUY 70 B	75	800*	10	15			1,0
BUY 70 C	75	500*	10	15			1,0
BUY 71	40	2200*	2				
BDX 31	40	2200*	4				
BDX 32	40	1700*	4				
2N 3439	Siehe Datenblatt Seite 2-301;		See Data Sheet Page 2-301				
2N 3440	Siehe Datenblatt Seite 2-301;		See Data Sheet Page 2-301				
2N 3583	2	35	175	1	40	200	0,5
2N 3584	2	35	250	2	8	140	1
2N 3585	2	35	300	2	8	140	1
2N 3902	4	100	325	2,5	30	90	1
2N 4240	2	35	300	2	6	240	0,75
2N 5157	4	100	400	3,5	30	90	1
2N 5241	4	125	325	5	15	35	2,5
TIP 525	4	(60)	200	5	30	150	2,5
TIP 531	4	(150)	300	15	20	120	7,5
TIP 532	4	(150)	400	15	20	120	7,5
TIP 533	4	(150)	300	15	20	120	7,5
TIP 534	4	(150)	400	15	20	120	7,5
TIP 535	5	(100)	200	7,5	20	100	5
TIP 536	5	(100)	200	7,5	20	100	5
TIP 537	5	(100)	400	7,5	20	100	5
TIP 538	5	(125)	200	15	20	100	7,5
TIP 539	5	(125)	300	15	20	100	7,5
TIP 540	5	(125)	400	15	20	100	7,5

f_T min MHz	* I_{CEV} (I_{CEO}) I_{CES} (I_{CE}) mA	V_{CE} V	Gehäuse package	Anwendungen, Bemerkungen applications, remarks
	(1)	1000	TO-3	Für Schalteranwendungen switching applications
	(1)	800	TO-3	
	(1)	500	TO-3	
	1	2200	TO-3	Fernsehanwendung, Horizontal-Ablenkendstufen in Sw TV horizontal deflection black and white
	1	2200	TO-3	Fernsehanwendung, Horizontal-Ablenkendstufen in Farbgeräten Color TV horizontal deflection
	1	1700	TO-3	
10	1	225	TO-66	Für industrielle und militärische Anwendung for industrial and military application
10	1	300	TO-66	
10	1	400	TO-66	
5	0,25	400	TO-3	
15	2	400	TO-66	
2,8	0,5	700	TO-3	Verstärker, schneller Schalter amplifier, high-speed switch
2,5	0,5	400	TO-3	
40	1	250	TO-3	
50	1	300	TO-3	Verstärker, schnelle Schaltenwendung, Netzgeräte amplifier, switch, power supply
50	1	400	TO-3	
50	1	300	TO-3	
50	1	400	TO-3	
10	1	300	TO-3	
10	1	400	TO-3	
10	1	500	TO-3	
10	1	300	TO-3	
10	1	400	TO-3	
10	1	500	TO-3	